

PATENT ASSIGNMENT

Electronic Version v1.1

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SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	ASSIGNMENT								
CONVEYING PARTY DATA									
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Chee Keong Chin</td><td>09/05/2008</td></tr><tr><td>Yu Feng Feng</td><td>09/05/2008</td></tr><tr><td>Wen Bin Qu</td><td>09/05/2008</td></tr></tbody></table>		Name	Execution Date	Chee Keong Chin	09/05/2008	Yu Feng Feng	09/05/2008	Wen Bin Qu	09/05/2008
Name	Execution Date								
Chee Keong Chin	09/05/2008								
Yu Feng Feng	09/05/2008								
Wen Bin Qu	09/05/2008								
RECEIVING PARTY DATA									
Name:	STATS ChipPAC Ltd.								
Street Address:	10 Ang Mo Kio Street 65								
Internal Address:	#05-17/20 Techpoint								
City:	Singapore								
State/Country:	SINGAPORE								
Postal Code:	569059								
PROPERTY NUMBERS Total: 2									
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>60971261</td></tr><tr><td>Application Number:</td><td>12207493</td></tr></tbody></table>		Property Type	Number	Application Number:	60971261	Application Number:	12207493		
Property Type	Number								
Application Number:	60971261								
Application Number:	12207493								
CORRESPONDENCE DATA									
Fax Number:	(408)738-0881								
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>									
Phone:	408-738-0592								
Email:	efiling@ishimarulaw.com								
Correspondent Name:	LAW OFFICES OF MIKIO ISHIMARU								
Address Line 1:	333 W. EL CAMINO REAL								
Address Line 2:	SUITE 330								
Address Line 4:	SUNNYVALE, CALIFORNIA 94087								
ATTORNEY DOCKET NUMBER:	27-464								
NAME OF SUBMITTER:	Mikio Ishimaru								

PATENT

500655651

REEL: 021574 FRAME: 0271

CH \$80.00 60971261

Total Attachments: 3

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ASSIGNMENT

WHEREAS, the undersigned (hereinafter termed Assignor(s)) has/have invented certain new and useful improvements in

MEMORY DEVICE SYSTEM WITH STACKED PACKAGES

for which a United States patent application has been executed on or before the date of this assignment;

WHEREAS, STATS ChipPAC Ltd., a Corporation of the Republic of Singapore, having a place of business at 10 Ang Mo Kio Street 65, #05-17/20 Techpoint, Singapore 569059, Republic of Singapore (hereinafter termed Assignee), is desirous of acquiring the entire right, title and interest in and to said application and said invention and improvements thereon, and in and to Letters Patents thereon when granted in the United States and foreign countries;

NOW, THEREFORE, for good and valuable consideration received by said Assignor(s) from said Assignee, the receipt of which is hereby acknowledged by said Assignor(s):

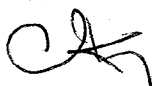
1. Said Assignor(s) does hereby sell, assign, transfer and convey unto said Assignee, the entire right, title and interest in and to said application and said invention and in and to any and all improvements on said invention and in and to any and all improvements on said invention heretofore or hereafter made or acquired by said Assignor(s); and in and to any and all Letters Patent on said invention and/or said improvements that may be granted in the United States or any foreign country, including each and every Letters Patent granted on any application which is a division, continuation, substitution, renewal, or continuation-in-part of any said application, and in and to each and every reissue or extension of said Letters Patent.
2. Said Assignor(s) hereby covenants and agrees to cooperate with said Assignee where said Assignee may enjoy to the fullest extent the right, title and interest herein conveyed. Such cooperation shall include (a) prompt execution of all papers (prepared at the expense of Assignee) which are deemed necessary or desirable by Assignee to perfect in it the right, title and interest herein conveyed, (b) prompt execution of all petitions, oaths, specifications or other papers (prepared at the expense of Assignee) which are deemed necessary or desirable by assignee for prosecuting said application, for filing and prosecuting divisional, continuation, substitution, renewal, continuation-in-part, or additional applications in the United States and/or foreign countries covering said invention and/or said improvements, for filing and prosecuting applications for reissuance of letters patent included herein, or for interference proceedings involving said invention and/or said improvements and (c) prompt assistance and cooperation in the prosecution of interference proceedings involving said invention and/or said improvements and in the adjudication of said Letters Patent, particularly by the disclosure of facts and the production of evidence relating to said invention and/or said improvements, provided the expenses which may be incurred by said Assignor(s) in lending such assistance and cooperation shall be paid by the Assignee.
3. The terms, covenants and conditions of this assignment shall inure to the benefit of said Assignee, its successors, assigns and/or other legal representatives and shall be binding upon said Assignor(s), his/her heirs, legal representatives and assigns.
4. Said Assignor(s) hereby warrants and represents that he/she has not entered into any assignment, contract or understanding in conflict herewith.

5. Said Assignor(s) hereby authorize and request the attorney(s) of record in this application to insert the serial number and filing date of this Non Provisional application and that of the Provisional application from which it claims priority in the spaces that follow:

Serial Number: 60/971,261 Filing Date: September 10, 2007

Serial Number: 12/207,493 Filing Date: September 9, 2008

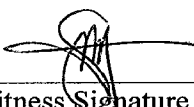
IN WITNESS WHEREOF, the said Assignor has executed and delivered this instrument on the date set forth below.



Chee Keong Chin

Sep 05 '08

Date



Witness Signature



Witness Signature

Michael V. Mercado Jr.

Ke Chen Liang

Sep. 05, 2008

Date

sep. 05, 2008

Date

IN WITNESS WHEREOF, the said Assignor has executed and delivered this instrument on the date set forth below.

Feng Feng
Yu Feng Feng

Sep 05 '08
Date

Wenbin
Witness Signature

Xia
Witness Signature

Liu Wenbin

Xia Elijah

9/5/08
Date

9/5/08
Date

IN WITNESS WHEREOF, the said Assignor has executed and delivered this instrument on the date set forth below.

Wen Bin Qu
Wen Bin Qu

Sep 05 '08
Date

Wenbin
Witness Signature

Xia
Witness Signature

Liu Wenbin

Xia Elijah

9/5/08
Date

9/5/08
Date